Test Report
For PMP10725
03/17/2016

TExAS INSTRUMENTS
1. Design Specifications

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>Vin Min</td>
<td>15VDC</td>
</tr>
<tr>
<td>Vin Max</td>
<td>36VDC</td>
</tr>
<tr>
<td>Vout1</td>
<td>24VDC</td>
</tr>
<tr>
<td>Iout1</td>
<td>500mA</td>
</tr>
<tr>
<td>Vout2</td>
<td>6VDC</td>
</tr>
<tr>
<td>Iout2</td>
<td>100mA</td>
</tr>
<tr>
<td>Vout3</td>
<td>6VDC</td>
</tr>
<tr>
<td>Iout3</td>
<td>100mA</td>
</tr>
<tr>
<td>Target Switching Frequency</td>
<td>200kHz</td>
</tr>
</tbody>
</table>

2. Circuit Description

PMP10725 is an isolated flyback solution which accepts an input voltage of 15 to 36V_{IN} and provides multiport output to the load. This reference design compares primary and secondary control solutions. With primary control, it can achieve higher efficiency with lower BOM cost, but the regulation performance is not so good. With secondary control, it can achieve great load regulation performance by controlling the 24V-rail voltage. This LM3481 flyback reference design can be used for supplying the digital output module in industrial PLC application.

2.1 Brief Comparison Table of Primary and Secondary Control

<table>
<thead>
<tr>
<th>Item</th>
<th>Primary Control</th>
<th>Secondary Control</th>
</tr>
</thead>
<tbody>
<tr>
<td>Efficiency</td>
<td>85.6% @ 15V_{IN} 100%load</td>
<td>84.8% @ 15V_{IN} 100%load</td>
</tr>
<tr>
<td></td>
<td>83.5% @ 36V_{IN} 100%load</td>
<td>81.3% @ 36V_{IN} 100%load</td>
</tr>
<tr>
<td>Regulation</td>
<td>-6.19% / +5.06% @ 15V_{IN}, 24V rail</td>
<td>-0.37% / +0.28% @ 15V_{IN}, 24V rail</td>
</tr>
<tr>
<td></td>
<td>-4.47% / +3.51% @ 36V_{IN}, 24V rail</td>
<td>-0.10% / +0.05% @ 36V_{IN}, 24V rail</td>
</tr>
<tr>
<td>BOM Quantity</td>
<td>43</td>
<td>50</td>
</tr>
<tr>
<td>Semiconductor Devices</td>
<td>Primary output diode</td>
<td>Opto coupler(PS2811)</td>
</tr>
<tr>
<td>(Ignore same devices)</td>
<td></td>
<td>Zener Shunt Regulator(LM431)</td>
</tr>
</tbody>
</table>

2.2 PLC Digital Output Module Power Tree
3. Board Photos

Top (66.37x22.61mm²)

Bottom (66.37x22.61mm²)
4. Thermal Data

IR thermal image taken at steady state at 100% load and $V_{IN} = 15 \text{ V}$ (secondary control) for two minutes with no airflow (4 Layer board, 1 Oz copper layer)

IR thermal image taken at steady state at 100% load and $V_{IN} = 36 \text{ V}$ (secondary control) for two minutes with no airflow (4 Layer board, 1 Oz copper layer)
5. Efficiency and Regulation

5.1 Efficiency Chart

The Efficiency measurement was taken in the condition that all three outputs were loaded at the same percentage current in respect of their full load.

![Efficiency Chart](image)

5.2 Cross Regulation Chart

The regulation under balanced load condition was tested as all three outputs were loaded with the same percentage of current in respect of their full load at different input voltage condition. Since two +6V outputs are symmetrical, only one +6V output regulation is shown.
The regulation under unbalanced load was tested by sweeping different load current on the 24V output while the two +6V output were loaded with 10mA, 50mA and 100mA at 24V input. Since the two +6V outputs are symmetrical, only one rail output regulation is shown.
24Vo Regulation_Primary Control

24Vo Regulation_Secondary Control
6. Waveform

6.1 Load Transient ($I_{o2}=I_{o3}=10mA$, $I_{o1}$: 100mA-400mA-100mA, 100mA/μS)

- $V_{IN}=15V$
- $V_{IN}=36V$

6.2 Start up

- $V_{IN}=15V$, $I_1=0$; $I_2=0$; $I_3=10mA$
- $V_{IN}=15V$, $I_1=0.1A$; $I_2=0.1A$; $I_3=0.5A$
- $V_{IN}=36V$, $I_1=0$; $I_2=0$; $I_3=10mA$
- $V_{IN}=36V$, $I_1=0.1A$; $I_2=0.1A$; $I_3=0.5A$
### 6.3 Shutdown

- **VIN=15V, I1=0; I2=0; I3=10mA**
- **VIN=15V, I1=0.1A; I2=0.1A; I3=0.5A**

- **VIN=36V, I1=0; I2=0; I3=10mA**
- **VIN=36V, I1=0.1A; I2=0.1A; I3=0.5A**

### 6.4 Ripple

- **VIN=15V, I1=0; I2=0; I3=50mA**
- **VIN=15V, I1=0.1A; I2=0.1A; I3=0.5A**
V_{IN}=36V, I_1=0; I_2=0; I_3=50mA

V_{IN}=36V, I_1=0.1A; I_2=0.1A; I_3=0.5A

6.5 Switching

V_{IN}=15V, I_1=0; I_2=0; I_3=50mA

V_{IN}=15V, I_1=0.1A; I_2=0.1A; I_3=0.5A

V_{IN}=36V, I_1=0; I_2=0; I_3=50mA

V_{IN}=36V, I_1=0.1A; I_2=0.1A; I_3=0.5A
6.6 Diode Voltage

- **V_{IN}=15V, I_1=0; I_2=0; I_3=50mA**
- **V_{IN}=15V, I_1=0.1A; I_2=0.1A; I_3=0.5A**
- **V_{IN}=36V, I_1=0; I_2=0; I_3=50mA**
- **V_{IN}=36V, I_1=0.1A; I_2=0.1A; I_3=0.5A**
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